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TRS3227E 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV IEC ESD PROTECTION

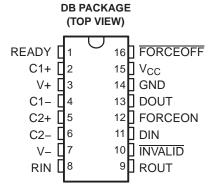
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FEATURES

- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V V_{CC} Supply
- Operates at Least 1 Mbit/s
- Low Standby Current . . . 1 μA Typ
- External Capacitors . . . 4 × 0.1 μF
- Accepts 5-V Logic Input With 3.3-V Supply
- Designed to Be Interchangeable With Industry Standard '3227E Devices
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection for RS-232 I/O Pins
 - ±15 kV Human-Body Model
 - ±8 kV IEC61000-4-2, Contact Discharge
 - ±15 kV IEC61000-4-2, Air-Gap Discharge
- Auto-Powerdown Plus Feature Automatically Disables Drivers for Power Savings
- Packaged in Plastic Shrink Small-Outline Package

APPLICATIONS

- Battery-Powered, Hand-Held, and Portable Equipment
- PDAs and Palmtop PCs
- Notebooks, Sub-Notebooks, and Laptops
- Digital Cameras
- Mobile Phones and Wireless Devices



DESCRIPTION/ORDERING INFORMATION

The TRS3227E consists of one line driver, one line receiver, and a dual charge-pump circuit with ±15-kV IEC ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. This device operates at data-signaling rates of 1 Mbit/s in normal operating mode and a maximum of 30-V/µs driver output slew rate. This device also features a logic-level output (READY) that asserts when the charge pump is regulating and the device is ready to begin transmitting.

The TRS3227E achieves a $1-\mu A$ supply current using the auto-powerdown plus feature. This device automatically enters a low-power powerdown mode when the RS-232 cable is disconnected or the drivers of the connected peripherals are inactive for more than 30 s. They turn on again when they sense a valid transition at any driver or receiver input. Auto-powerdown saves power without changes to the existing BIOS or operating system.

The TRS3227EC is characterized for operation from 0°C to 70°C. The TRS3227EI is characterized for operation from –40°C to 85°C.

ORDERING INFORMATION

| T _A | PACKA | (GE ⁽¹⁾⁽²⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|-----------------------|-----------------------|------------------|
| 0°C to 70°C | SSOP – DB | Reel of 2000 | TRS3227ECDBR | RS27EC |
| -40°C to 85°C | SSOP – DB | Reel of 2000 | TRS3227EIDBR | RS27EI |

⁽¹⁾ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

AA.

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⁽²⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

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TEXAS INSTRUMENTS www.ti.com

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FUNCTION TABLE(1)

| | INPUT CO | NDITIONS | | | OUTPUT S | STATES | | |
|---------|----------|--|---|-----------|---------------|---------|-------|--|
| FORCEON | FORCEOFF | RECEIVER OR DRIVER EDGE WITHIN 30 s | VALID RS-232 LEVEL PRESENT AT RECEIVER | DRIVER | RECEIVER | ĪNVALID | READY | OPERATING MODE |
| | | | Auto- | Powerdow | n Plus Condit | ions | | |
| Н | Н | NO | NO | Active | Active | L | Н | Normal operation, auto-powerdown plus disabled |
| Н | Н | NO | YES | Active | Active | Н | Н | Normal operation, auto-powerdown plus disabled |
| L | Н | YES | NO | Active | Active | L | Н | Normal operation, auto-powerdown plus enabled |
| L | Н | YES | YES | Active | Active | Н | Н | Normal operation, auto-powerdown plus enabled |
| L | Н | NO | NO | Z | Active | L | L | Powerdown, auto-powerdown plus enabled |
| L | Н | NO | YES | Z | Active | Н | L | Powerdown, auto-powerdown plus enabled |
| Х | L | X | NO | Z | Active | L | L | Manual powerdown |
| Х | L | Х | YES | Z | Active | Н | L | Manual powerdown |
| | | | Au | to-Powerd | own Condition | ns | | |
| INVALID | INVALID | Х | NO | Z | Active | L | L | Powerdown, auto-powerdown enabled |
| INVALID | INVALID | Х | YES | Active | Active | Н | Н | Normal operation, auto-powerdown enabled |

⁽¹⁾ H = high level, L = low level, X = irrelevant, Z = high impedance

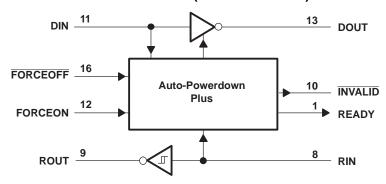
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TERMINAL FUNCTIONS

| TERMINA | AL | DESCRIPTION |
|------------------------------|-----------|---|
| NAME | NO. | DESCRIPTION |
| C1+ | 2 | Positive terminal of voltage-doubler charge-pump capacitor |
| C1- | 4 | Negative terminal of voltage-doubler charge-pump capacitor |
| C2+ | 5 | Positive terminal of inverting charge-pump capacitor |
| C2- | 6 | Negative terminal of inverting charge-pump capacitor |
| DIN | 11 | CMOS driver input |
| DOUT 13 RS-232 driver output | | |
| FORCEOFF | 16 | Force-off input, active low. Drive low to shut down drivers, receivers, and charge pump. This overrides auto-shutdown and FORCEON (see Function Table). |
| FORCEON | 12 | Force-on input, active high. Drive high to override powerdown, keeping drivers and receivers on (FORCEOFF must be high) (see Function Table). |
| GND | 14 | Ground |
| INVALID | 10 | Valid signal detector output, active low. A logic high indicates that a valid RS-232 level is present on a receiver input. |
| READY | 1 | Ready to transmit output, active high. READY is enabled high when V- goes below -3.5 V and the device is ready to transmit. |
| RIN | 8 | RS-232 receiver input |
| ROUT | 9 | CMOS receiver output |
| V+ | 3 | $+2 \times V_{CC}$ generated by the charge pump |
| V- | 7 | $-2 \times V_{CC}$ generated by the charge pump |
| V _{CC} | 15 | 3-V to 5.5-V single-supply voltage |

LOGIC DIAGRAM (POSITIVE LOGIC)



TRS3227E

3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH \pm 15-kV IEC ESD PROTECTION



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Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|------------------|---|--|------------|----------------|------|
| V _{CC} | Supply voltage range ⁽²⁾ | | -0.3 | 6 | V |
| V+ | Positive output supply voltage range (2) | | -0.3 | 7 | V |
| V- | Negative output supply voltage range (2) | egative output supply voltage range ⁽²⁾ | | -7 | V |
| V+ - V- | Supply voltage difference ⁽²⁾ | Ţ. | | 13 | V |
| V _I | Input voltage range | Driver (FORCEOFF, FORCEON) | -0.3 | 6 | V |
| | input voltage range | Receiver | -25 | 25 | |
| V | Output valtage range | Driver | -13.2 13.2 | V | |
| Vo | Output voltage range | Receiver (INVALID, READY) | -0.3 | $V_{CC} + 0.3$ | V |
| | Short-circuit duration | DOUT to GND | | Unlimited | |
| θ_{JA} | Package thermal impedance (3) | | | 82 | °C/W |
| | Lead temperature 1,6 mm (1/16 in) from case | se for 10 s | | 260 | °C |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Recommended Operating Conditions(1)

See Figure 5

| | | | | MIN | NOM | MAX | UNIT |
|----------|---|---|-------------------------|-----|-----|-----|------|
| | Cumply voltage | | V _{CC} = 3.3 V | 3 | 3.3 | 3.6 | V |
| | Supply voltage | | V _{CC} = 5 V | 4.5 | 5 | 5.5 | V |
| V | Driver and control high-level input voltage | and control high-level input voltage DIN, FORCEOFF, FORCEON | V _{CC} = 3.3 V | 2 | | 5.5 | V |
| V_{IH} | Driver and control high-level input voltage | DIN, FORCEOFF, FORCEON | $V_{CC} = 5 V$ | 2.4 | | 5.5 | ' |
| V_{IL} | Driver and control low-level input voltage | DIN, FORCEOFF, FORCEON | | 0 | | 0.8 | V |
| VI | Receiver input voltage | | | -25 | | 25 | V |
| _ | Operating free cir temperature | | TRS3227EC | 0 | | 70 | 0 |
| IA | Operating free-air temperature TRS322 | | | -40 | | 85 | °C |

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V.

Electrical Characteristics(1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

| | PARA | METER | TEST CONDITIONS | MIN | TYP ⁽²⁾ | MAX | UNIT |
|-----------------|-------------------------|---|---|-----|--------------------|-----|------|
| I | Input leakage current | FORCEOFF, FORCEON | | | ±0.01 | ±1 | μΑ |
| | | Auto-powerdown plus disabled No load, FORCEOFF and FORCEON at V _{CC} | 0.3 | 2 | mA | | |
| I _{CC} | Supply current | Powered off | No load, FORCEOFF at GND | | 1 | 10 | |
| | (T _A = 25°C) | Auto-powerdown plus enabled | No load, FORCEOFF at V _{CC} , FORCEON at GND, All RIN are open or grounded | | 1 | 10 | μΑ |

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 $V \pm 0.3$ V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 $V \pm 0.5$ V.

⁽²⁾ All voltages are with respect to network GND.

⁽³⁾ The package thermal impedance is calculated in accordance with JESD 51-7.

⁽²⁾ All typical values are at $V_{CC} = 3.3 \text{ V}$ or $V_{CC} = 5 \text{ V}$, and $T_A = 25 ^{\circ}\text{C}$.

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DRIVER SECTION

Electrical Characteristics(1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1 and Figure 2)

| | PARAMETER | TEST C | ONDITIONS | | MIN | TYP ⁽²⁾ | MAX | UNIT |
|------------------|----------------------------------|---|-----------------------|------------------------------|------------|--------------------|-----|------|
| V_{OH} | High-level output voltage | DOUT at $R_L = 3 \text{ k}\Omega$ to GND, | DIN = GND | | 5 | 5.4 | | V |
| V _{OL} | Low-level output voltage | DOUT at $R_L = 3 \text{ k}\Omega$ to GND, | DIN = V _{CC} | | - 5 | -5.4 | | V |
| I _{IH} | High-level input current | $V_I = V_{CC}$ | | | | ±0.01 | ±1 | μΑ |
| I _{IL} | Low-level input current | V _I at GND | | | | ±0.01 | ±1 | μΑ |
| | Short-circuit output current (3) | V _{CC} = 3.6 V, | V _O = 0 V | | | ±35 | ±60 | mΛ |
| Ios | Short-circuit output current | $V_{CC} = 5.5 \text{ V},$ | $V_O = 0 V$ | | | ±35 | ±60 | mA |
| r _o | Output resistance | V_{CC} , V+, and V- = 0 V, | V _O = ±2 V | | 300 | 10M | | Ω |
| I _{off} | Output leakage current | FORCEOFF = GND, | $V_0 = \pm 12 V$, | V _{CC} = 0 to 5.5 V | | | ±25 | μΑ |

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 $V \pm 0.3 \ V$; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 $V \pm 0.5 \ V$.

Switching Characteristics⁽¹⁾

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1 and Figure 2)

| | PARAMETER | Т | EST CONDITIONS | | MIN | TYP ⁽²⁾ | MAX | UNIT |
|--------------------|---------------------------------|---|---|--------------------|------|--------------------|-----|--------|
| Maximum dat | | C _L = 1000 pF, One DIN switching, | $R_L = 3 \text{ k}\Omega$, See Figure 1 | | 250 | | | |
| | Maximum data rate | C _L = 1000 pF, V _{CC} = 4.5 V, | $R_L = 3 \text{ k}\Omega$, See Figure 1 | One DIN switching, | 1000 | | | kbit/s |
| | | C _L = 250 pF, V _{CC} = 3 V, | $R_L = 3 \text{ k}\Omega$, See Figure 1 | One DIN switching, | 1000 | | | |
| t _{sk(p)} | Pulse skew ⁽³⁾ | $C_L = 150 \text{ pF to } 2500 \text{ pF},$ | $R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega,$ | See Figure 2 | | 25 | | ns |
| SR(tr) | Slew rate, transition region | $V_{CC} = 3.3 \text{ V},$ $C_L = 150 \text{ pF to } 1000 \text{ pF},$ | $R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega,$ See Figure 1 | | 24 | | 150 | V/µs |

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V. (2) All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and V_{CC} = 5 V. (3) Pulse skew is defined as $|V_{CC}| = 1000$ f each channel of the same device.

ESD Protection

| TERMIN | IAL | TEST CONDITIONS | TYP | LINIT |
|--------|-----|----------------------------------|-----|-------|
| NAME | NO. | TEST CONDITIONS | ITP | UNIT |
| | | Human-Body Model | ±15 | |
| DOUT | 13 | Contact Discharge (IEC61000-4-2) | ±8 | kV |
| | | Air-Gap Discharge (IEC61000-4-2) | ±15 | |

All typical values are at $V_{CC} = 3.3 \text{ V}$ or $V_{CC} = 5 \text{ V}$, and $T_A = 25^{\circ}\text{C}$. Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

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RECEIVER SECTION

Electrical Characteristics⁽¹⁾

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 3)

| | PARAMETER | TEST CONDITIONS | MIN | TYP ⁽²⁾ | MAX | UNIT |
|-------------------|---|--|-----------------------|-----------------------|-----|------|
| V_{OH} | High-level output voltage | $I_{OH} = -1 \text{ mA}$ | V _{CC} - 0.6 | V _{CC} - 0.1 | | V |
| V_{OL} | Low-level output voltage | I _{OL} = 1.6 mA | | | 0.4 | V |
| W | Positive-going input threshold voltage | V _{CC} = 3.3 V | | 1.5 | 2.4 | V |
| V _{IT+} | Positive-going input tineshold voltage | V _{CC} = 5 V | | 1.8 | | v |
| V | Negative-going input threshold voltage | V _{CC} = 3.3 V | 0.6 | 1.2 | | V |
| V _{IT} – | Negative-going input threshold voltage | V _{CC} = 5 V | 0.8 | 1.5 | | V |
| V_{hys} | Input hysteresis (V _{IT+} - V _{IT-}) | | | 0.5 | | V |
| I_{off} | Output leakage current | | | ±0.05 | ±10 | μA |
| r _l | Input resistance | $V_1 = \pm 3 \text{ V to } \pm 25 \text{ V}$ | 3 | 5 | 7 | kΩ |

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V. (2) All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

Switching Characteristics⁽¹⁾

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | TYP ⁽²⁾ | UNIT |
|--------------------|---|---------------------------------------|--------------------|------|
| t _{PLH} | Propagation delay time, low- to high-level output | C _L = 150 pF, See Figure 3 | 150 | ns |
| t _{PHL} | Propagation delay time, high- to low-level output | C _L = 150 pF, See Figure 3 | 150 | ns |
| t _{sk(p)} | Pulse skew ⁽³⁾ | See Figure 3 | 50 | ns |

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V. (2) All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C. (3) Pulse skew is defined as $|t_{PLH}|$ of each channel of the same device.

ESD Protection

| TERMI | NAL | TEST COMPITIONS | TYP | UNIT |
|-------|-----|----------------------------------|-----|------|
| NAME | NO. | TEST CONDITIONS | | UNII |
| | | Human-Body Model | ±15 | |
| RIN | 8 | Contact Discharge (IEC61000-4-2) | ±8 | kV |
| | | Air-Gap Discharge (IEC61000-4-2) | ±15 | |

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AUTO-POWERDOWN SECTION

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)

| | PARAMETER | TEST CONDITIONS | MIN | MAX | UNIT |
|-------------------------|--|---|-----------------------|-----|------|
| V _{T+(valid)} | Receiver input threshold for INVALID high-level output voltage | FORCEON = GND, FORCEOFF = V _{CC} | | 2.7 | V |
| V _{T-(valid)} | Receiver input threshold for INVALID high-level output voltage | FORCEON = GND, FORCEOFF = V _{CC} | -2.7 | | V |
| V _{T(invalid)} | Receiver input threshold for INVALID low-level output voltage | FORCEON = GND, FORCEOFF = V _{CC} | -0.3 | 0.3 | V |
| V _{OH} | INVALID, READY output voltage high | I _{OH} = -1 mA, FORCEON = GND, FORCEOFF = V _{CC} | V _{CC} - 0.6 | | V |
| V _{OL} | INVALID, READY output voltage low | I _{OL} = 1.6 mA, FORCEON = GND, FORCEOFF = V _{CC} | | 0.4 | V |

Switching Characteristics

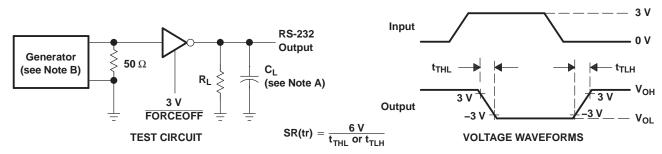
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)

| | PARAMETER | | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|-----------------------|---|-----------------------|-----|--------------------|-----|------|
| t_{INVH} | Propagation delay time, low- to high-level output | | | 1 | | μs |
| t _{INVL} | Propagation delay time, high- to low-level output | | 30 | | μs | |
| t _{WU} | Supply enable time | | | 100 | | μs |
| t _{AUTOPRDN} | Driver or receiver edge to driver's shutdown | V _{CC} = 5 V | 15 | 30 | 60 | s |

⁽¹⁾ All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.



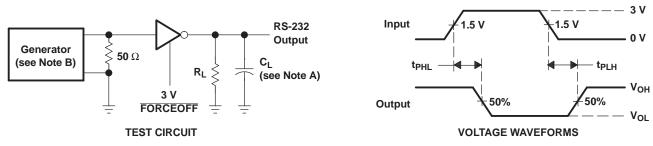
PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s, Z_{O} = 50 Ω , 50% duty cycle, t_{f} \leq 10 ns, t_{f} \leq 10 n

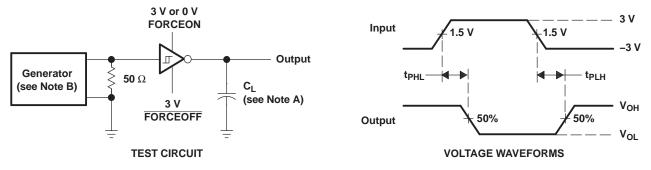
Figure 1. Driver Slew Rate



NOTES: A. C_I includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s, Z_{O} = 50 Ω , 50% duty cycle, t_{f} \leq 10 ns, t_{f} \leq 10 ns.

Figure 2. Driver Pulse Skew



NOTES: A. C_L includes probe and jig capacitance.

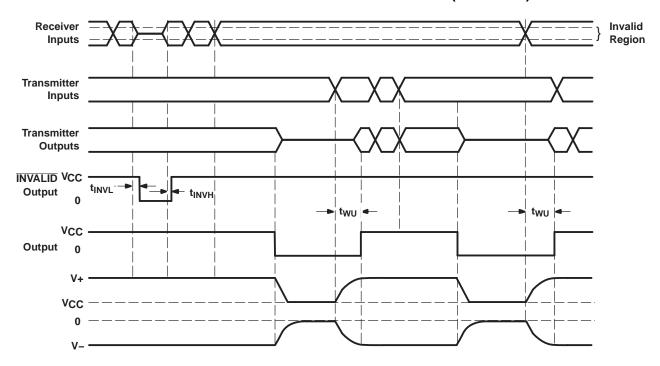
B. The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, 50% duty cycle, $t_r \le 10$ ns. $t_f \le 10$ ns.

Figure 3. Receiver Propagation Delay Times

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PARAMETER MEASUREMENT INFORMATION (continued)



VOLTAGE WAVEFORMS

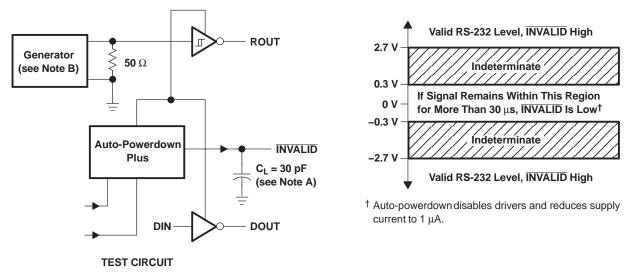
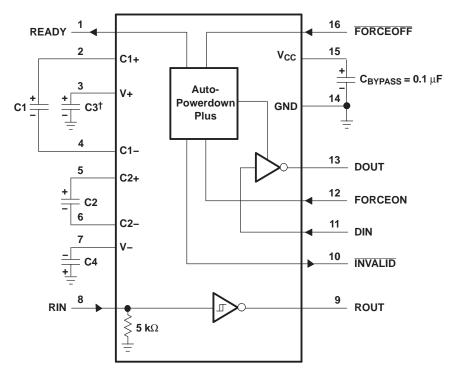


Figure 4. INVALID Propagation Delay Times and Driver Enabling Time



APPLICATION INFORMATION



 $^{^{\}dagger}$ C3 can be connected to V_{CC} or GND.

- NOTES: A. Resistor values shown are nominal.
 - B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

V_{CC} vs CAPACITOR VALUES

| V _{CC} | C1 | C2, C3, and C4 |
|--|------------------------------|------------------------------|
| $\begin{array}{c} \textbf{3.3 V} \pm \textbf{0.3 V} \\ \textbf{5 V} \pm \textbf{0.5 V} \\ \textbf{3 V to 5.5 V} \end{array}$ | 0.1 μF 0.047 μF 0.1 μF | 0.1 μF 0.33 μF 0.47 μF |

Figure 5. Typical Operating Circuit and Capacitor Values





10-Dec-2020

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| TRS3227ECDB | ACTIVE | SSOP | DB | 16 | 80 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | RS27EC | Samples |
| TRS3227ECDBR | ACTIVE | SSOP | DB | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | RS27EC | Samples |
| TRS3227EIDB | ACTIVE | SSOP | DB | 16 | 80 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | RS27EI | Samples |
| TRS3227EIDBR | ACTIVE | SSOP | DB | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | RS27EI | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TRS3227ECDBR | SSOP | DB | 16 | 2000 | 330.0 | 16.4 | 8.35 | 6.6 | 2.4 | 12.0 | 16.0 | Q1 |
| TRS3227EIDBR | SSOP | DB | 16 | 2000 | 330.0 | 16.4 | 8.35 | 6.6 | 2.4 | 12.0 | 16.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TRS3227ECDBR | SSOP | DB | 16 | 2000 | 853.0 | 449.0 | 35.0 |
| TRS3227EIDBR | SSOP | DB | 16 | 2000 | 853.0 | 449.0 | 35.0 |

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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